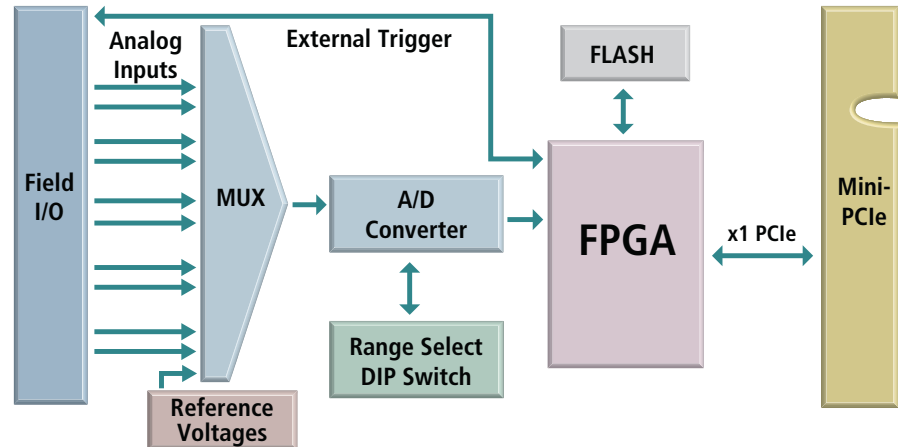
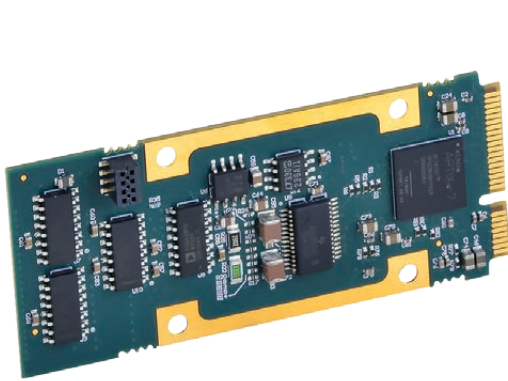


AcroPack® Modules

AP323 16-bit ADC High Density Analog Input



16-bit ADC ♦ 20 Differential or 40 Single-Ended Channels ♦ Wide Temp. Range ♦ PCIe Bus Interface

Description

Model: AP323E-LF

The AcroPack® product line updates our popular Industry Pack I/O modules with a PCIe interface format. This **COTS tech-refresh** design offers a compact size, low-cost I/O in a rugged form factor. Combine different AcroPack modules on one carrier for a simplified modular approach to system assembly.

AP323E-LF AcroPack model monitors 20 differential or 40 single-ended input channels. When used with a carrier that holds four AP modules, up to 160 inputs can be obtained from a single card gage slot.

Software or an external hardware input can trigger A/D conversions for synchronization to external events.

On-board, precision voltage references enable accurate software calibration of the module without external instruments.

Designed for COTS applications these analog input modules deliver high-density, high-reliability, and high-performance at a low cost.

AcroPack modules are RoHS compliant and ideal for military, defense, automation, aerospace, scientific, and development labs industries.

The AP323E-LF modules are 70mm long, 19.05mm longer than the full length mini PCIe card. The board's width is the same as mPCIe board and use the same mPCIe standard board hold down standoff and screw keep out areas.

A down facing 100 pin Samtec connector mates with the carrier card. Fifty of these signals are available as field I/O signals.

Key Features & Benefits

- PCI Express Generation 1 interface
- 20 differential or 40 single-ended inputs
- Mix and match countless I/O combinations in a single slot.
- Flexible scan control
- 8µs conversion time
- FIFO buffer with 16K sample memory
- Interrupt upon FIFO threshold condition
- FIFO full, empty and threshold reached flags
- Programmable channel conversion control
- Programmable conversion timer
- Several scanning modes
- External trigger
- Solid-down connector I/O interface
- Wide temperature range
- PCIe, VPX and XMC carriers
- Linux®, Windows®, and VxWorks® support



AP323 16-bit ADC High Density Analog Input

Performance Specifications

Analog Input

Input configuration
20 differential or 40 single-ended.

A/D Resolution
16 bits.

Input range (dip switch-selectable)
Bipolar $\pm 5V$ or $\pm 10V$
Unipolar 0 to $+5V$ or 0 to $+10V$

Data sample memory
16K sample FIFO buffer.

Maximum throughput rate
200KHz (5 μ S/conversion).

A/D triggers
External, and software.

System accuracy
2.4 LSB (0.014%)

Maximum overall calibrated error at 25°C

Input Range (Volts)	ADC Range (Volts)	Maximum Error \pm LSB (%span)	Typical Error \pm LSB (%span)
± 5	± 5	± 8.6 LSB (0.013%)	± 4 LSB (0.006%)
± 10	± 10	± 9.4 LSB (0.014%)	± 3 LSB (0.005%)

Data format
Binary two's complement and straight binary.

Input overvoltage protection
Power on: $-20V$ to $+40V$.
Power off: $-35V$ to $+55V$

Common mode rejection ratio (60Hz)
96dB typical.

Channel-to-channel rejection ratio (60Hz)
96dB typical.

PCI Express Base Specification

Conforms to PCIe base specification
Revision 2.1.

Lanes
1 lane in each direction.

Bus Speed
2.5 Gbps (Generation 1).

Memory
4k space required.
1 base address register.

Environmental

Operating temperature
 -40 to $70^\circ C$.
 -40 to $85^\circ C$.
(requires an AcroPack heatsink conduction-cool kit)

Storage temperature
 -40 to $85^\circ C$.

Relative humidity
5 to 95% non-condensing.

Power
3.3 VDC $\pm 5\%$ 400mA typical, 500mA maximum.
5.0 VDC $\pm 5\%$ 20mA typical, 30mA maximum.
 ± 12 VDC $\pm 5\%$ 0.7mA typical, 1.4mA maximum.

Physical

Length
70mm.

Width
30mm.

Ordering Information

AcroPack® Modules

[AP323E-LF](#)
20 differential or 40 single-ended inputs, 16-bit
(Note: AcroPack modules are compatible only with the carriers listed below)

Accessories

[AP-CC-01](#)
Conduction-cool kit

Carrier Cards

[APCe7010E-LF](#)
PCIe AcroPack carrier, holds one AcroPack module, air-cooled.

[APCe7020E-LF](#)
PCIe AcroPack carrier, holds two AcroPack modules, air-cooled.

[APCe7040E-LF](#)
PCIe AcroPack carrier, holds four AcroPack modules, air-cooled.

[VPX4500E-LF](#)
3U VPX AcroPack carrier, holds three AcroPack modules, air-cooled.

[VPX4500-CC-LF](#)
3U VPX AcroPack carrier, holds three AcroPack modules, conduction-cooled.

[XMCAP2020-LF](#)
XMC AcroPack carrier; holds two AcroPack modules, 2-slots out front, air-cooled.

[XMCAP2021-LF](#)
XMC AcroPack carrier; holds two AcroPack modules, 2-slots out rear, air-cooled.

Software (see software documentation for details)

[APSW-API-VXW](#)
VxWorks® software support package.

[APSW-API-WIN](#)
Windows® DLL driver software support package.

[APSW-API-LNX](#)
Linux® support (website download only).



AP-CC-01 Conduction-Cool Kit

ISO9001
AS9100

MADE IN USA

Acromag 
THE LEADER IN INDUSTRIAL I/O

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